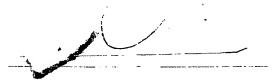
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PATENT NUMBER

U.S. UTILITY Patent Application

O.I.P.E. PATENT DATE	
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APPLICATION NO. CONT/PRIOR CLASS BALMEISTER SUBCLASS ART UNIT 09/522707 DF 257 615

Kazumasa Hiramatsu Hideto Miyake Takayoshi Maeda Yasushi Iyechika

III-V compound semiconductor

ISSUING CLASSIFICATION							
ORIGINAL	·	CROSS REFERENCE(S)					
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TERMINAL DISCLAIMER	DRAWINGS			CLAIMS ALLOWED		
	Sheets Drwg.	· Figs. Drwg.	Print Fig.	Total Claims	Print Claim for O.G.	
The term of this patent subsequent to (date)				NOTICE OF ALL	OWANCE MAILED	
has been disclaimed.	(Assistant E	xaminer)	(Date)			
The term of this patent shall not extend beyond the expiration date	- 14.	,			;	
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				Amount Due	Date Paid	
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